

Order Account Manager: Sarah Chang
Phone: 408 735 7137 x 9955

Printed On: Jun 20 2013 1:29PM

Order Information

Order Number: 276010-iQ-1
Procim ID: 118279
Order Date: 06-20-2013
Order Type: CQ
Sales Order Number: (Live)
Lot number:
Tool Number: (Live)

Part Summary

Quantity: 6
Layers: 2
Part Number: Stress Board rev
Member ID: LarryH23
Name: Larry Hackett
Company: Fairchild Semiconductor
AFVST: 93908
CAM1 : SATISH

Designer/Engineer Contact

Larry Hackett
FAIRCHILD SEMICONDUCTOR
Email: larry.hackett@fairchildsemi.com
Phone: (408) 822-2593
24 Hour contact person: none provided
24 Hour Phone Number:
Production Due Date: 25 Jun 2013
Production Turntime: 3 Days

MIN.PTH:14.5 MIL
MAX.PTH:40 MIL
1 MIL DRILL INCREASED
LOGO IN TOP SILK
SECONDARY DRILL

Layers: 2
Indv Brd Dimensions:7.135 in x 5.713 in
Array:No
Number of Part numbers: 1

Shipping Method: Driver option
Ship Code*: LOCAL (As per Shipping Method)

[Request: R197197X](#)

[Request created in June 2013]

Requester's Time Zone:---

Board Type: Dont Know

Outside Sales Rep Info if applicable	
Outside Sales Rep Co.	-
Outside Sales Rep name	-

(Stress Board One art files (Version 1B)_zip) [R197197X-set2.zip](#)

Product Name Custom Quote

ITAR? : No	Array by Sierra : No	Min. Space(o/l) : 5 mils	Logo Allowed : In copper or silk screen ^^
BOM Available? : No	Ind. Route : Yes	Min. Trace(i/l) : Not Applicable	#of Holes/Bd : 63
Electrical Test : Yes	Route/Retain : No	Min. Space(i/l) : Not Applicable	Min. Hole Size : 10mils
Aerospace Appl : No	Scoring : No	Solder Mask : Yes	Etchback : No
Medical Appl : No	Small Inside Rad. : N/A	SM Sides : Top and Bottom	Ground on O/L : Yes
Single Job Batch? : No	Material : Nan Ya NP-175	SM Color : Green	Internal Cutouts : None
Pre-STA check : STA Check Done: Okay to proceed	Fin. Thickness : 0.032 inches	SM Type : LPI	x-sectn cert : No
Gerbers provided? : Yes	Thickness Tol. : Plus or Minus 10% ^^	SM Finish : Standard (Semi-Gloss) ^^	micro-sectn coupn : No
Layer Order? : Yes	Surface Finish : Lead Free HASL	Make Material : No	Internal Slots : None
Board Outline? : Yes	Gold Fingers : No	Silk Screen : Yes	SM Via Opens : Covered on both sides
Drill File? : Yes	Starting Copper : Not Specified By The Customer	Silk Screen Sides : Top	SM Plugged Vias : No
Fab Drawing? : Yes	O/L Finish Cu : 1.5 Oz	UL Required : No	Backer Board : No
IPC Netlist? : No	Inner Copper : Not Applicable	Silk Screen Color : White	Photo plots : No
PCB Spec : IPC-600 Class 2 ^^	Contr. Impdnc. : None	Silk Screen method : Any	Aprvl check plots? : No
Multi part Gerbers : Not Applicable	Controlled Dielectric : No	ROHS compliant : Yes	Plot trnsfr cust : None
Array : No	Min. Trace(o/l) : 10 mils	Rohs Marking : Yes	S.Paste files to cust : No

Not sure due to missing information ## Not sure due to discrepancy
» Sure By Customer Resolution >>>Sure By Customer Over-ride
^^Sure by Convention *Ship code automatically assigned by system as per algorithm

Issues / Resolutions

ssdc_sandeep - Jun 19 2013 3:09PM **Issue 1 (Copied from PD197197-2A)**
1) Gerber input received VIA_BOTTOM.art and VIA_TOP.art layers, we are not sure about these layers and whether the requirement of Sm plugging or not.
spe_sarahc - Jun 20 2013 11:54AM (Copied from PD197197-2A)
Per customer, ignore those layers.

Admin Notes

spe_reneey/Jun 19 2013 3:09PM
(**Notes automatically copied from original part data specs**)
checked in by sandeep

ssdc_prasad/Jun 17 2013 4:06PM

Customer Instructions

Notes for Sales

Billing Notes

Shipping Notes

Notes For Engineering

SS81506

1 of 2

Hanumesh G 6/20/2013

OTHER ADMIN NOTES

Current Ancillary Documents for this Request

Document Name	Document Type	Created By	Created Date	Creation Notes
No Record(s) found!				

Information from Quote

FYI: Sales person (or system) has quoted this job based on **1** panels of size **18 X 24**

Quoted Usable Size	16.2 X 22.2
Quoted Panel Interboard Spacing X	0.2
Quoted Panel Interboard Spacing Y	0.2

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End of Engineering SORF Order# 276010-iQ-1

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Tool#:	Due Date: 25 Jun 2013
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Batch Matching / Disqualification form

Order Information Order Number: 276010-iQ-1 Order Date: 06-20-2013 Order Type: CQ Sales Order Number: (Live) Tool Number: (Live)	Part Summary Quantity: 6 Layers: 2 Part Number: Stress Board rev Member ID: LarryH23 Name: Larry Hackett Company: Fairchild Semiconductor	Designer/Engineer Contact Larry Hackett FAIRCHILD SEMICONDUCTOR Email: larry.hackett@fairchildsemi.com Phone: (408) 822-2593 24 Hour contact person: none provided 24 Hour Phone Number: Production Due Date: 25 Jun 2013 Production Turntime: 3 Days
Layers: 2 Indv Brd Dimensions: 7.135 in x 5.713 in Array: No Number of Part numbers: 1 Board Parameters:		

Layer #	Thickness	Material Type	Surface Finish
2	0.032 inches	Nan Ya NP-175	Lead Free HASL
I/L Copper Wt	O/L Copper Wt	Ground plane on outer layer	Board Size/ Array Size
Not Applicable	1.5 Oz	Yes	Indv Brd Dimensions: 7.135 in x 5.713 in Array: No 7.135" X 5.713" Individual Size
Silkscreen color	Soldermask color	FYI, QUICK PANELIZATION CALCULATION (Assuming board is Class 2, No Controlled Impedance or Gold-Fingers)	Date due
White	Green	18 X 24 panels needed: 1 12 X 18 panels needed: 1	25 Jun 2013